



Product Change Notification

113335 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113335 - 00
Change Title: Boxed Intel® NUC Kit D34010WYK, 5 Pack,
Boxed Intel® NUC Kit D54250WYK, 5 Pack,
PCN 113335-00
Product Design
Update HDD Daughter Card Resister
Date of Publication: October 22, 2014

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Nov 04, 2014
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Description of Change to the Customer:

A resistor value on the SATA Hard Disk Drive Daughter Card will be changed from 2K ohms to 1.5K ohms to increase drive strength.

Customer Impact of Change and Recommended Action:

This change has been evaluated to ensure there is no quality, reliability, or functional implication to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Post Change SA
BOXD54250WYKH	932421	H25101-103	H25101-104
BOXD54250WYKH1	932422	H26245-103	H26245-104
BOXD54250WYKH2	932423	H26246-103	H26246-104
BOXD54250WYKH3	932424	H26247-103	H26247-104
BOXD34010WYKH	932425	H25115-103	H25115-104
BOXD34010WYKH1	932426	H26248-103	H26248-104
BOXD34010WYKH2	932427	H26249-103	H26249-104
BOXD34010WYKH3	932428	H26250-103	H26250-104

PCN Revision History:

Date of Revision:

October 22, 2014

Revision Number:

00

Reason:

Originally Published PCN